AF Control LSI

Overview

This LSI is Closed–Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built–in EEPROM and temperature sensor.

Features

- Built-in Equalizer Circuit Using Digital Operation
 - AF Control Equalizer Circuit
 - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface (The communication protocol is compatible with I2C)
- Built-in A/D Converter
- Built-in D/A Converter
 - ♦ Hall Offset
 - Constant Current Bias
- Built-in Hall Sensor
 - Si Hall Sensor
- Built-in EEPROM
 - ♦ 64byte (16byte/page)
- Built-in OSC
- Built–in Constant Current Driver
 110 mA
- Package
 - WL–CSP 6–pin (2 x 3pin), Thickness Max 0.29 mm, with Backside Coat
 - ◆ Lead-free, Halogen-free
- Supply voltage
 - V_{DD} (2.6 V to 3.3 V)



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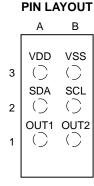
WLCSP 6 BUMP CASE 567UK

DEVICE MARKING INFORMATION



8229= Specific Device Code

- Y = Year
- M = Month
- ZZ = Assembly Lot



(Top View)

Circuit Name	Number of PINs
Driver	2
Power	2
Logic	2

ORDERING INFORMATION

Device	Package	Shipping [†]
LC898229XI	WLCSP6	4000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Pin Description

	Туре
I	Input
0	Output
В	Bidirection
Р	Power supply, GND
NC	Not Connected

2-wire Serial Interface						
SCL I 2–wire serial interface clock p						
SDA	В	2-wire serial interface data pin				

Driver Interface						
OUT1	0	Driver output (to Actuator)				
OUT2	0	Driver output (to Actuator)				

Power Supply Pin						
V _{DD}	Р	Power supply				
V _{SS}	Р	GND				

*Process when Pins are Not Used

PIN TYPE "O" – Ensure that it is set to OPEN.

PIN TYPE "I" – OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused.

(Please contact ON Semiconductor for more information about selection of VDD or VSS.)

PIN TYPE "B" – If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

Table 1. ABSOLUTE MAXIMUM RATING (VSS = 0 V)

Item	Symbol	Condition	Rating	Unit
Supply voltage	V _{DD} 33 max	Ta ≤ 25°C	-0.3~4.6	V
Input/output voltage	V _I 33, V _O 33	Ta ≤ 25°C	-0.3~V _{DD} 33+0.3	V
Storage ambient temperature	Tstg		-55~125	°C
Operating ambient temperature	Topr		-30~70	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 2. ACCEPTABLE OPERATION RANGE at Ta = -30 ~ 70°C, VSS = 0 V

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{DD} 33	2.6	2.8	3.3	V
Input voltage range	V _{IN}	0		V _{DD} 33	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 3. DC CHARACTERISTICS: Input/output level at VSS = 0 V, VDD = 2.6 V ~ 3.3V, Ta = -30 ~ 70°C

Item	Symbol	Condition	Min	Тур	Max	Unit	Applicable Pins
High-level input voltage	V _{IH}	CMOS compliant Schmidt	1.4			V	SCL, SDA
Low-level input voltage	V _{IL}	Schmidt			0.4	V	
Low-level output voltage	V _{OL}	IOL= 2mA			0.2	V	SDA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 4. DRIVER OUTPUT (OUT1, OUT2) at VSS = 0 V, VDD = 2.8 V, Ta = 25°C

ltem	Symbol	Condition	Min	Тур	Max	Unit	Applicable Pins
Maximum current	I _{full}		105	110	115	mA	OUT1, OUT2

Table 5. NON-VOLATILE MEMORY CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Мах	Unit	Applicable Circuit
Endurance	EN				1000	Cycles	EEPROM
Data retention	RT		10			Years	
Write time	t _{WT}				20	ms	

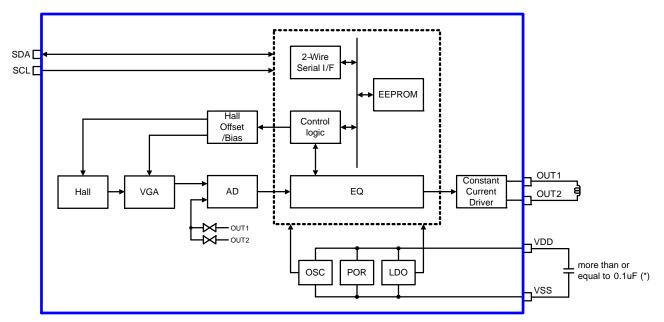


Figure 1. Block Diagram

NOTE: Consider capacitance of capacitor between V_{DD} and V_{SS}. According to power source environment, attach an additional capacitor in camera module.

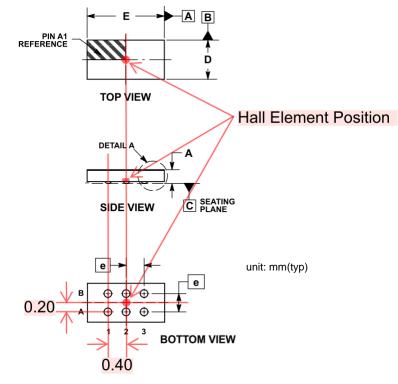


Figure 2. Hall Element Position

NOTE: Please refer to package diagram for each dimension.

AC Characteristics

VDD Supply Timing VDD VSS SCL/SDA

Figure 3. VDD Supply Timing

It is available to use 2-wire serial interface 5ms later for Power On Reset of VDD.

Item	Symbol	Min	Тур	Max	Unit
V _{DD} turn on time	t1			3	ms
2-wire serial interface start time from VDD on	t2	5			ms
V _{DD} off time	t3	100			ms
Bottom Voltage	Vbot			0.1	V

AC Specification

Figure 4 shows interface timing definition and Table 6 shows electric characteristics.

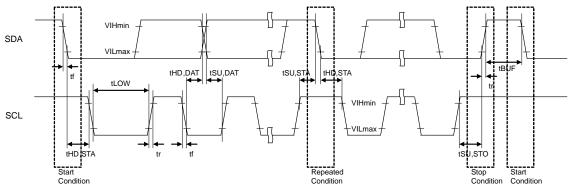


Figure 4. 2–wire Serial Interface Timing Definition

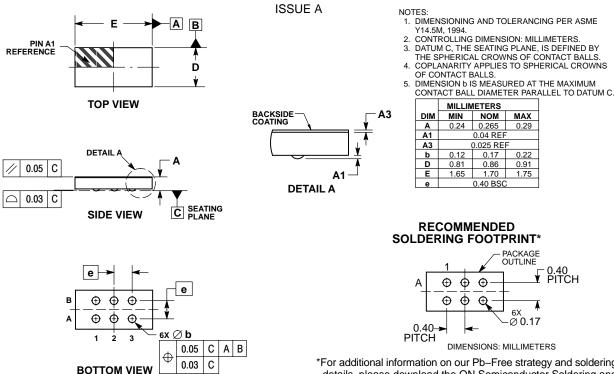
ltem	Symbol	Pin Name	Fast-mode			Fast-mode Plus			
			Min	Тур	Max	Min	Тур	Max	Units
SCL clock frequency	FSCL	SCL			400			1000	KHz
START condition hold time	t _{HD} , STA	SCL, SDA	0.6			0.26			μs
SCL clock Low period	t _{LOW}	SCL	1.3			0.5			μs
SCL clock High period	t _{HIGH}	SCL	0.6			0.26			μs
Setup time for repetition START condition	t _{SU} , STA	SCL, SDA	0.6			0.26			μS
Data hold time	t _{HD} , DAT	SCL, SDA	0 (Note 1)		0.9	0 (Note 1)			μs
Data setup time	t _{SU} , DAT	SCL, SDA	100			50			ns
SDA, SCL rising time	t _r	SCL, SDA			300			120	ns
SDA, SCL falling time	t _f	SCL, SDA			300			120	ns
STOP condition setup time	t _{SU} , STO	SCL, SDA	0.6			0.26			μs
Bus free time between STOP and START	t _{BUF}	SCL, SDA	1.3			0.5			μs

1. This LSI is designed for a condition with typ. 20ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

PACKAGE DIMENSIONS

WLCSP6 0.86x1.70x0.265

CASE 567UK



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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